

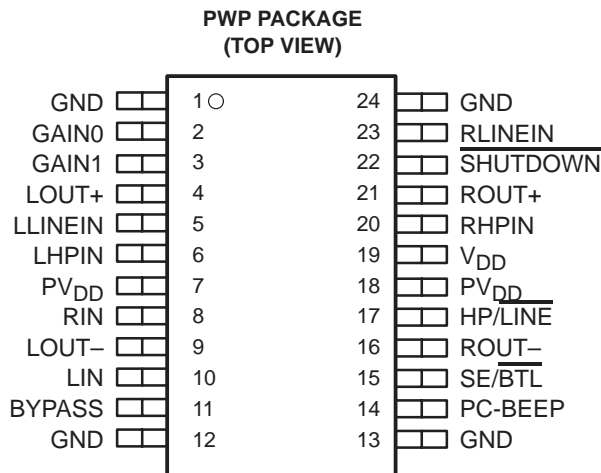
# TPA0212

## STEREO 2-W AUDIO POWER AMPLIFIER

### WITH FOUR SELECTABLE GAIN SETTINGS AND MUX CONTROL

SLOS284A – NOVEMBER 1999 – NOVEMBER 2000

- Compatible With PC 99 Desktop Line-Out Into 10-k $\Omega$  Load
- Internal Gain Control, Which Eliminates External Gain-Setting Resistors
- 2-W/Ch Output Power Into 3- $\Omega$  Load
- Input MUX Select Terminal
- PC-Beep Input
- Depop Circuitry
- Stereo Input MUX
- Fully Differential Input
- Low Supply Current and Shutdown Current
- Surface-Mount Power Packaging 24-Pin TSSOP PowerPAD™



#### description

The TPA0212 is a stereo audio power amplifier in a 24-pin TSSOP thermally enhanced package capable of delivering 2 W of continuous RMS power per channel into 3- $\Omega$  loads. This device minimizes the number of external components needed, simplifying the design, and freeing up board space for other features. When driving 1 W into 8- $\Omega$  speakers, the TPA0212 has less than 0.8% THD+N across its specified frequency range.

Included within this device is integrated depop circuitry that virtually eliminates transients that cause noise in the speakers.

Amplifier gain is internally configured and controlled by way of two terminals (GAIN0 and GAIN1). BTL gain settings of 2, 6, 12, and 24 V/V are provided, while SE gain is always configured as 1 V/V for headphone drive. An internal input MUX allows two sets of stereo inputs to the amplifier. The HP/LINE terminal allows the user to select which MUX input is active regardless of whether the amplifier is in SE or BTL mode. In notebook applications, where internal speakers are driven as BTL and the line outputs (often headphone drive) are required to be SE, the TPA0212 automatically switches into SE mode when the SE/BTL input is activated, and this reduces the gain to 1 V/V.

The TPA0212 consumes only 6 mA of supply current during normal operation. A miserly shutdown mode reduces the supply current to less than 150  $\mu$ A.

The PowerPAD package (PWP) delivers a level of thermal performance that was previously achievable only in TO-220-type packages. Thermal impedances of approximately 35°C/W are readily realized in multilayer PCB applications. This allows the TPA0212 to operate at full power into 8- $\Omega$  loads at an ambient temperature of 85°C.

#### AVAILABLE OPTIONS

T <sub>A</sub>	PACKAGED DEVICE
	TSSOP† (PWP)
-40°C to 85°C	TPA0212PWP

† The PWP package is available taped and reeled. To order a taped and reeled part, add the suffix R to the part number (e.g., TPA0212PWPR).



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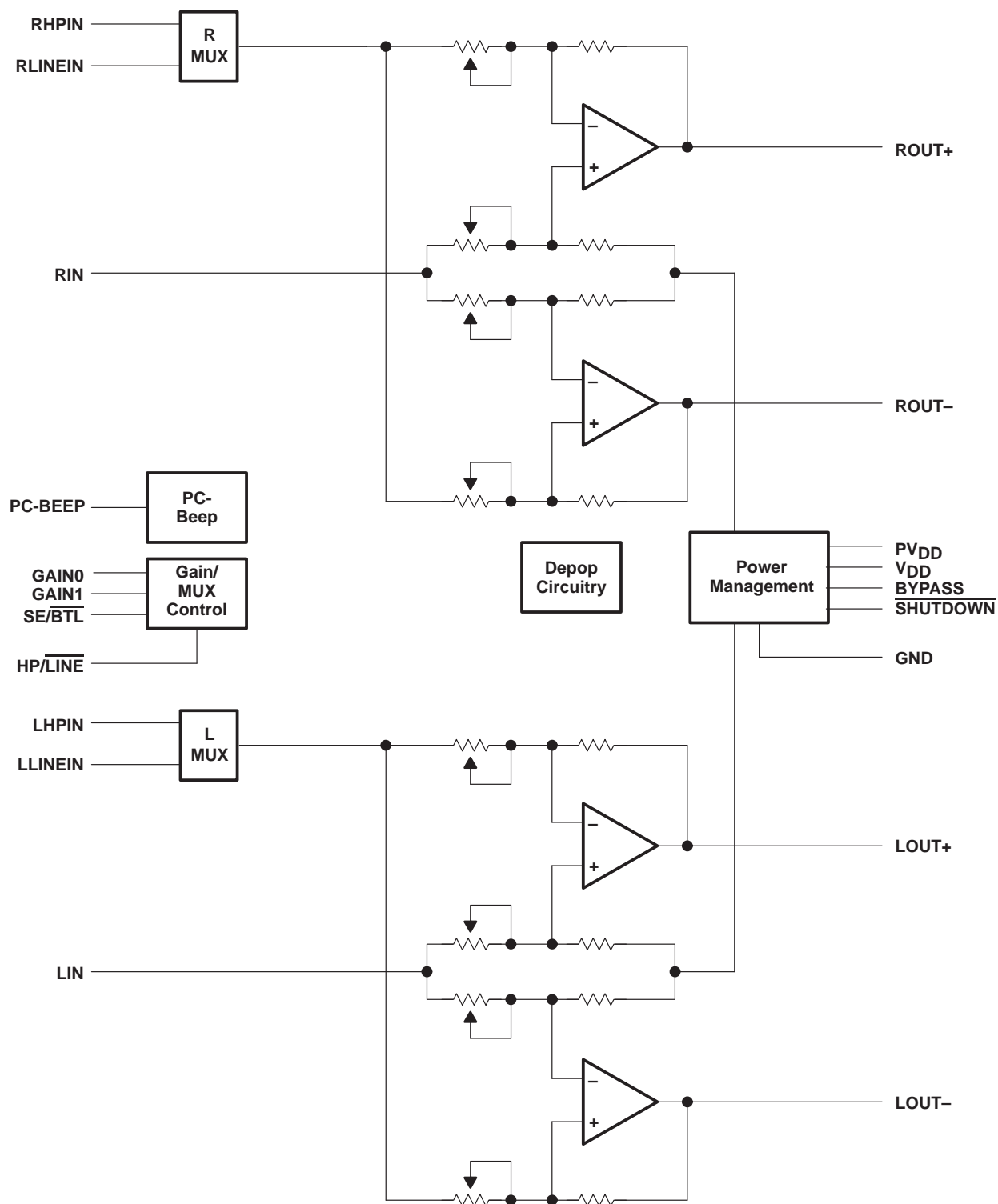
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#### functional block diagram



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**Terminal Functions**

TERMINAL NAME	NO.	I/O	DESCRIPTION
BYPASS	11		Tap to voltage divider for internal mid-supply bias generator
GAIN0	2	I	Bit 0 of gain control
GAIN1	3	I	Bit 1 of gain control
GND	1, 12, 13, 24		Ground connection for circuitry. Connected to the thermal pad.
LHPIN	6	I	Left channel headphone input, selected when $\overline{\text{SE/BTL}}$ is held high
LIN	10	I	Common left input for fully differential input. AC ground for single-ended inputs.
LLINEIN	5	I	Left channel line input, selected when $\overline{\text{SE/BTL}}$ is held low
LOUT+	4	O	Left channel positive output in BTL mode and positive output in SE mode
LOUT–	9	O	Left channel negative output in BTL mode and high-impedance in SE mode
PC-BEEP	14	I	The input for PC-Beep mode. PC-BEEP is enabled when a > 1-V (peak-to-peak) square wave is input to PC-BEEP or PCB ENABLE is high.
HP/ $\overline{\text{LINE}}$	17	I	HP/ $\overline{\text{LINE}}$ is the input MUX control input. When the $\overline{\text{HP/LINE}}$ terminal is held high, the headphone inputs (LHPIN or RHPIN [6, 20]) are active. When the $\overline{\text{HP/LINE}}$ terminal is held low, the line BTL inputs (LLINEIN or RLINEIN [5, 23]) are active.
PV <sub>DD</sub>	7, 18	I	Power supply for output stage
RHPIN	20	I	Right channel headphone input, selected when $\overline{\text{SE/BTL}}$ is held high
RIN	8	I	Common right input for fully differential input. AC ground for single-ended inputs.
RLINEIN	23	I	Right channel line input, selected when $\overline{\text{SE/BTL}}$ is held low
ROUT+	21	O	Right channel positive output in BTL mode and positive output in SE mode
ROUT–	16	O	Right channel negative output in BTL mode and high-impedance in SE mode
$\overline{\text{SHUTDOWN}}$	22	I	Places entire IC in shutdown mode when held low, except PC-BEEP remains active
$\overline{\text{SE/BTL}}$	15	I	Hold $\overline{\text{SE/BTL}}$ low for BTL mode and hold high for SE mode.
V <sub>DD</sub>	19	I	Analog V <sub>DD</sub> input supply. This terminal needs to be isolated from PV <sub>DD</sub> to achieve highest performance.



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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage, $V_{DD}$	6 V
Input voltage, $V_I$	–0.3 V to $V_{DD} + 0.3$ V
Continuous total power dissipation	internally limited (see Dissipation Rating Table)
Operating free-air temperature range, $T_A$	–40°C to 85°C
Operating junction temperature range, $T_J$	–40°C to 150°C
Storage temperature range, $T_{stg}$	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

**DISSIPATION RATING TABLE**

PACKAGE	$T_A \leq 25^\circ\text{C}$	DERATING FACTOR	$T_A = 70^\circ\text{C}$	$T_A = 85^\circ\text{C}$
PWP	2.7 W†	21.8 mW/°C	1.7 W	1.4 W

† Please see the Texas Instruments document, *PowerPAD Thermally Enhanced Package Application Report* (literature number SLMA002), for more information on the PowerPAD package. The thermal data was measured on a PCB layout based on the information in the section entitled *Texas Instruments Recommended Board for PowerPAD* on page 33 of the before mentioned document.

**recommended operating conditions**

		MIN	MAX	UNIT
Supply voltage, $V_{DD}$		4.5	5.5	V
High-level input voltage, $V_{IH}$	SE/BTL, HP/LINE	4		V
	SHUTDOWN	2		
Low-level input voltage, $V_{IL}$	SE/BTL, HP/LINE		3	V
	SHUTDOWN		0.8	
Operating free-air temperature, $T_A$		–40	85	°C

**electrical characteristics at specified free-air temperature,  $V_{DD} = 5$  V,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$ V_{OO} $ Output offset voltage (measured differentially)	$V_I = 0$ $A_V = -2$ V/V			25	mV
PSRR Power supply rejection ratio	$V_{DD} = 4$ V to 5 V		77		dB
$ I_{IH} $ High-level input current	$V_{DD} = 5.5$ V, $V_I = V_{DD}$			900	nA
$ I_{IL} $ Low-level input current	$V_{DD} = 5.5$ V $V_I = 0$ V			900	nA
$I_{DD}$ Supply current	BTL mode		6	8	mA
	SE mode		3	4	
$I_{DD(SD)}$ Supply current, shutdown mode		150	300		μA



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**operating characteristics,  $V_{DD} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $R_L = 8\ \Omega$ , Gain =  $-2\text{ V/V}$ , BTL mode**

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
$P_O$	Output power	THD = 1%, $f = 1\text{ kHz}$ , $R_L = 4\ \Omega$			1.9		W
THD + N	Total harmonic distortion plus noise	$P_O = 1\text{ W}$ , $f = 20\text{ Hz to }15\text{ kHz}$			0.75%		
$B_{OM}$	Maximum output power bandwidth	THD = 5%			>15		kHz
	Supply ripple rejection ratio	$f = 1\text{ kHz}$ , $C_{(BYP)} = 0.47\ \mu\text{F}$	BTL mode,		68		dB
SNR	Signal-to-noise ratio				105		dB
$V_n$	Noise output voltage	$C_{(BYP)} = 0.47\ \mu\text{F}$ , $f = 20\text{ Hz to }20\text{ kHz}$	BTL mode		16		$\mu\text{V}_{RMS}$
			SE mode		30		
$Z_i$	Input impedance			See Table 1			

## TYPICAL CHARACTERISTICS

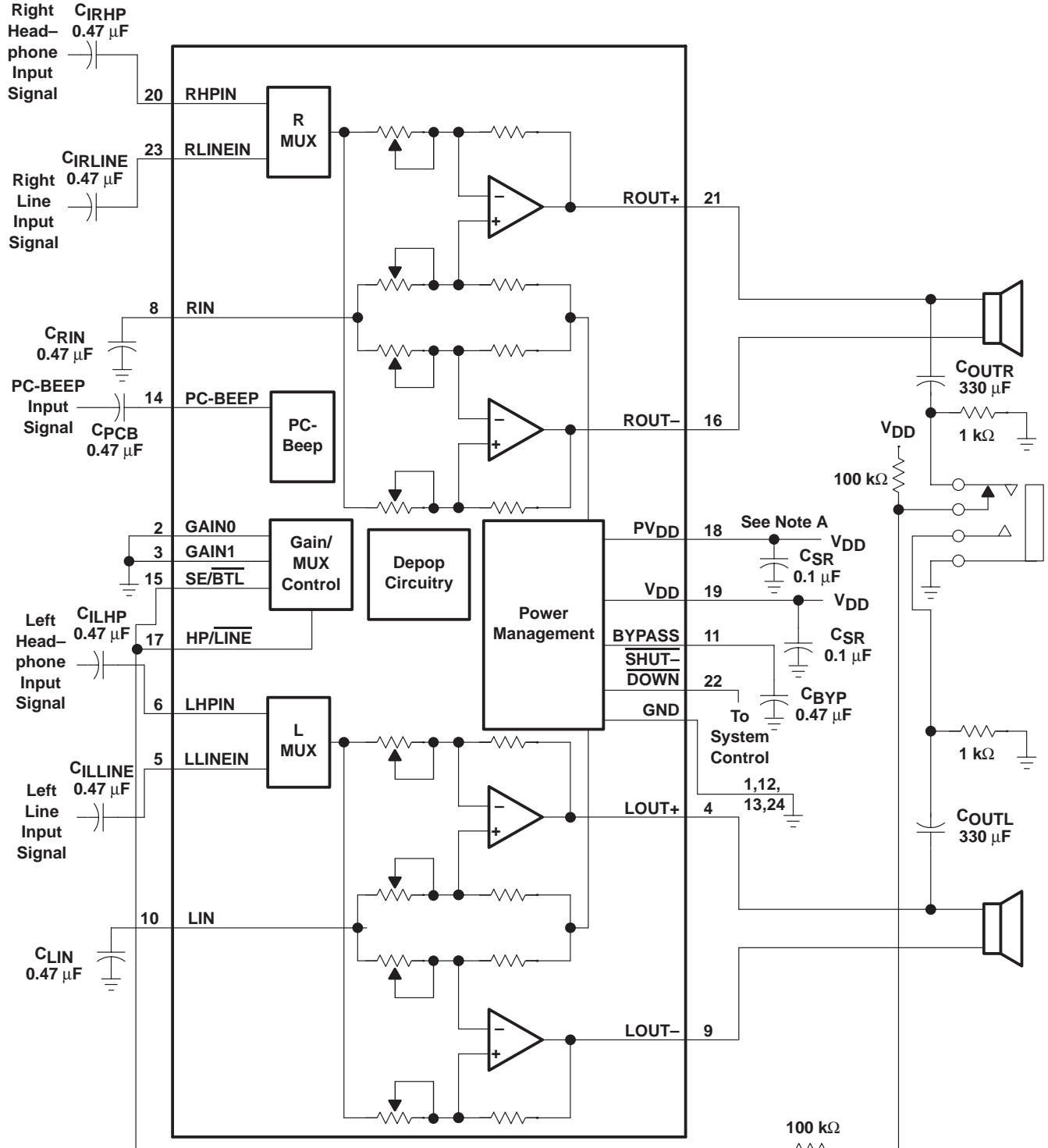
Table of Graphs

		FIGURE
THD+N	Total harmonic distortion plus noise	vs Output power
		1, 4–7, 10–13, 16–19, 21
		vs Frequency
		2, 3, 8, 9, 14, 15, 20, 22
		vs Output voltage
		23
$V_n$	Output noise voltage	vs Bandwidth
		24
	Supply ripple rejection ratio	vs Frequency
		25, 26
	Crosstalk	vs Frequency
		27–29
	Shutdown attenuation	vs Frequency
		30
SNR	Signal-to-noise ratio	vs Frequency
		31
	Closed loop response	
		32–35
$P_O$	Output power	vs Load resistance
		36, 37
$P_D$	Power dissipation	vs Output power
		38, 39
		vs Ambient temperature
		40



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**APPLICATION INFORMATION**



NOTE A: A 0.1  $\mu\text{F}$  ceramic capacitor should be placed as close as possible to the IC. For filtering lower-frequency noise signals, a larger electrolytic capacitor of 10  $\mu\text{F}$  or greater should be placed near the audio power amplifier.

**Figure 42. Typical TPA0212 Application Circuit Using Single-Ended Inputs and Input MUX**

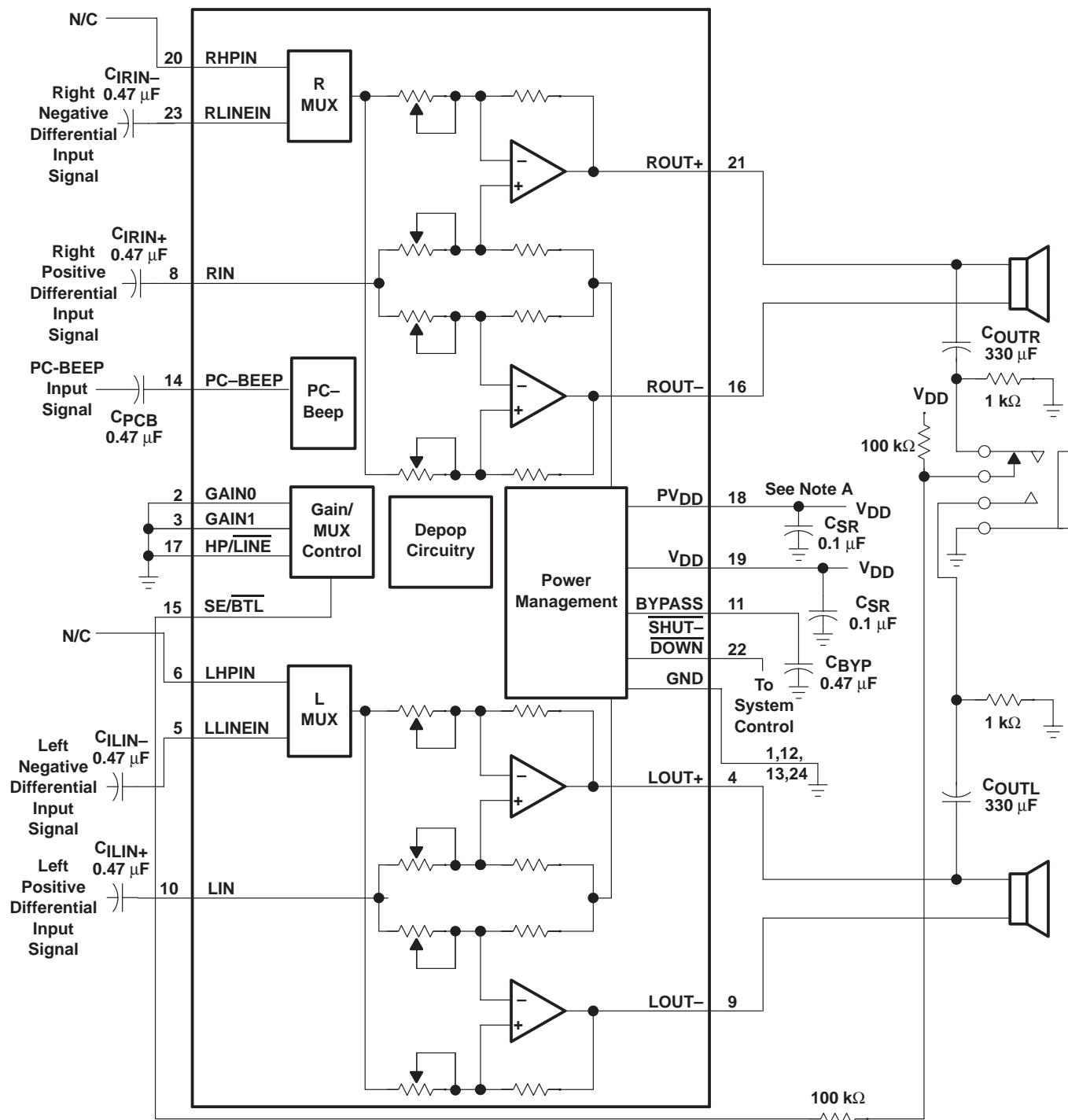
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Figure 43. Typical TPA0212 Application Circuit Using Differential Inputs